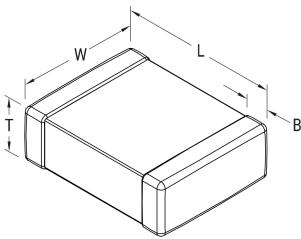


## C1206X681JBGACAUTO

SMD Auto COG HV Flex, Ceramic, 680 pF, 5%, 630 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, Automotive Grade, 1206



Click here for the 3D model.

Dimensions	
Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
Т	1mm +/-0.20mm
В	0.6mm +/-0.25mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

SMD Auto COG HV Flex
SMD Chip
${\sf SMD}, {\sf MLCC}, {\sf FT-CAP}, {\sf Ultra-Stable}, {\sf Automotive} \\ {\sf Grade}$
FT-CAP, Ultra-Stable, Automotive Grade
Yes
Flexible Termination
No
AEC-Q200
Yes
25 mg
78 Weeks
1

Specifications	
Capacitance	680 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	630 VDC
Dielectric Withstanding Voltage	945 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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